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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	XCore
Core Size	32-Bit 10-Core
Speed	2000MIPS
Connectivity	USB
Peripherals	-
Number of I/O	81
Program Memory Size	-
Program Memory Type	ROMIess
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	0.95V ~ 3.6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	128-TQFP Exposed Pad
Supplier Device Package	128-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/xmos/xu210-512-tq128-c20

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

1 xCORE Multicore Microcontrollers

The xCORE-200 Series is a comprehensive range of 32-bit multicore microcontrollers that brings the low latency and timing determinism of the xCORE architecture to mainstream embedded applications. Unlike conventional microcontrollers, xCORE multicore microcontrollers execute multiple real-time tasks simultaneously and communicate between tasks using a high speed network. Because xCORE multicore microcontrollers are completely deterministic, you can write software to implement functions that traditionally require dedicated hardware.

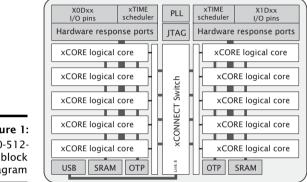


Figure 1: XU210-512-TQ128 block diagram

Key features of the XU210-512-TQ128 include:

- ► **Tiles**: Devices consist of one or more xCORE tiles. Each tile contains between five and eight 32-bit xCOREs with highly integrated I/O and on-chip memory.
- Logical cores Each logical core can execute tasks such as computational code, DSP code, control software (including logic decisions and executing a state machine) or software that handles I/O. Section 6.1
- xTIME scheduler The xTIME scheduler performs functions similar to an RTOS, in hardware. It services and synchronizes events in a core, so there is no requirement for interrupt handler routines. The xTIME scheduler triggers cores on events generated by hardware resources such as the I/O pins, communication channels and timers. Once triggered, a core runs independently and concurrently to other cores, until it pauses to wait for more events. Section 6.2
- Channels and channel ends Tasks running on logical cores communicate using channels formed between two channel ends. Data can be passed synchronously or asynchronously between the channel ends assigned to the communicating tasks. Section 6.5
- xCONNECT Switch and Links Between tiles, channel communications are implemented over a high performance network of xCONNECT Links and routed through a hardware xCONNECT Switch. Section 6.6

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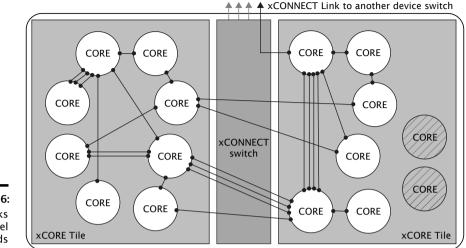


Figure 6: Switch, links and channel ends

Information on the supported routing topologies that can be used to connect multiple devices together can be found in the XS1-U Link Performance and Design Guide, X2999.

7 PLL

The PLL creates a high-speed clock that is used for the switch, tile, and reference clock. The initial PLL multiplication value is shown in Figure 7:

Figure 7: The initial PLL multiplier values

Z. LL	Oscillator	Tile Boot	PLL Ratio	PLL :	settin	gs
er	Frequency	Frequency		OD	F	R
es	9-25 MHz	144-400 MHz	16	1	63	0

Figure 7 also lists the values of OD, F and R, which are the registers that define the ratio of the tile frequency to the oscillator frequency:

$$F_{core} = F_{osc} \times \frac{F+1}{2} \times \frac{1}{R+1} \times \frac{1}{OD+1}$$

OD, *F* and *R* must be chosen so that $0 \le R \le 63$, $0 \le F \le 4095$, $0 \le OD \le 7$, and $260MHz \le F_{osc} \times \frac{F+1}{2} \times \frac{1}{R+1} \le 1.3GHz$. The *OD*, *F*, and *R* values can be modified by writing to the digital node PLL configuration register.

If the USB PHY is used, then either a 24 MHz or 12 MHz oscillator must be used.

If a different tile frequency is required (eg, 500 MHz), then the PLL must be reprogrammed after boot to provide the required tile frequency. The XMOS tools

The program size and CRC are stored least significant byte first. The program is loaded into the lowest memory address of RAM, and the program is started from that address. The CRC is calculated over the byte stream represented by the program size and the program itself. The polynomial used is 0xEDB88320 (IEEE 802.3); the CRC register is initialized with 0xFFFFFFFF and the residue is inverted to produce the CRC.

8.1 Boot from QSPI master

If set to boot from QSPI master, the processor enables the six pins specified in Figure 10, and drives the SPI clock at 50 MHz (assuming a 400 MHz core clock). A READ command is issued with a 24-bit address 0x000000. The clock polarity and phase are 0 / 0.

	Pin	Signal	Description
	X0D01	SS	Slave Select
Figure 10:	X0D04X0D07	SPIO	Data
QSPI pins	X0D10	SCLK	Clock

The xCORE Tile expects each byte to be transferred with the *least-significant nibble first*. Programmers who write bytes into an QSPI interface using the most significant nibble first may have to reverse the nibbles in each byte of the image stored in the QSPI device.

The pins used for QSPI boot are hardcoded in the boot ROM and cannot be changed. If required, an QSPI boot program can be burned into OTP that uses different pins.

8.2 Boot from SPI master

If set to boot from SPI master, the processor enables the four pins specified in Figure 11, and drives the SPI clock at 2.5 MHz (assuming a 400 MHz core clock). A READ command is issued with a 24-bit address 0x000000. The clock polarity and phase are 0 / 0.

Pin Signal Description X0D00 MISO Master In Slave Out (Data) Figure 11: X0D01 SS Slave Select SPI master X0D10 SCLK Clock pins X0D11 MOSI Master Out Slave In (Data)

The xCORE Tile expects each byte to be transferred with the *least-significant bit first*. Programmers who write bytes into an SPI interface using the most significant bit first may have to reverse the bits in each byte of the image stored in the SPI device.

If a large boot image is to be read in, it is faster to first load a small boot-loader that reads the large image using a faster SPI clock, for example 50 MHz or as fast as the flash device supports.



13 DC and Switching Characteristics

Symbol	Parameter	MIN	ТҮР	MAX	UNITS	Notes
VDD	Tile DC supply voltage	0.95	1.00	1.05	V	
VDDIOL	I/O supply voltage	3.135	3.30	3.465	V	
VDDIOR	I/O supply voltage	3.135	3.30	3.465	V	
VDDIOT 3v3	I/O supply voltage	3.135	3.30	3.465	V	
VDDIOT 2v5	I/O supply voltage	2.375	2.50	2.625	V	
USB_VDD	USB tile DC supply voltage	0.95	1.00	1.05	V	
VDD33	Peripheral supply	3.135	3.30	3.465	V	
PLL_AVDD	PLL analog supply	0.95	1.00	1.05	V	
Cl	xCORE Tile I/O load capacitance			25	pF	
Та	Ambient operating temperature (Commercial)	0		70	°C	
	Ambient operating temperature (Industrial)	-40		85	°C	
Тј	Junction temperature			125	°C	
Tstg	Storage temperature	-65		150	°C	

13.1 Operating Conditions

Figure 21: Operating conditions

13.2 DC Characteristics, VDDIO=3V3

Symbol	Parameter	MIN	ТҮР	MAX	UNITS	Notes
V(IH)	Input high voltage	2.00		3.60	V	A
V(IL)	Input low voltage	-0.30		0.70	V	А
V(OH)	Output high voltage	2.20			V	B, C
V(OL)	Output low voltage			0.40	V	B, C
I(PU)	Internal pull-up current (Vin=0V)	-100			μA	D
I(PD)	Internal pull-down current (Vin=3.3V)			100	μA	D
I(LC)	Input leakage current	-10		10	μA	

Figure 22: DC characteristics

A All pins except power supply pins.

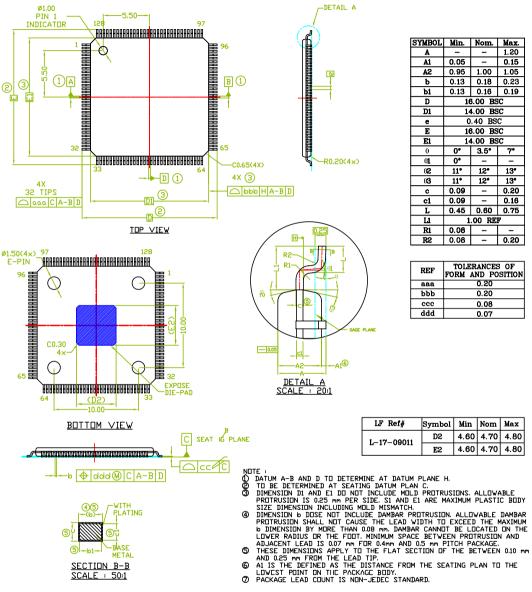
B Pins X1D40, X1D41, X1D42, X1D43, X1D26, and X1D27 are nominal 8 mA drivers, the remainder of the general-purpose I/Os are 4 mA.

C Measured with 4 mA drivers sourcing 4 mA, 8 mA drivers sourcing 8 mA.

D Used to guarantee logic state for an I/O when high impedance. The internal pull-ups/pull-downs should not be used to pull external circuitry. In order to pull the pin to the opposite state, a 4K7 resistor is recommended to overome the internal pull current.



14 **Package Information**



INDOP	Min.	NOIL.	max.	
A	-	-	1.20	
A1	0.05	-	0.15	
A2	0.95	1.00	1.05	
đ	0.13	0.18	0.23	
b1	0.13	0.16	0.19	
D	10	3.00 BS	SC	
D1	14	4.00 BS	SC .	
e	0.40 BSC			
E	16.00 BSC			
El	14.00 BSC			
θ	0"	3.5°	7°	
61	0*	-	-	
62	11•	12*	13*	
6 3	11*	12*	13*	
с	0.09	-	0.20	
c1	0.09	-	0.16	
L	0.45	0.60	0.75	
LI	1.00 REF			
R1	0.08	-	-	
R2	0.08	-	0.20	

REF	TOLERANCES OF FORM AND POSITION
aaa	0.20
bbb	0.20
ccc	0.08
ddd	0.07

LF Ref#	Symbol	Min	Nom	Max
L-17-09011	D2	4.60	4.70	4.80
	E2	4.60	4.70	4.80

XS2-U10A-512-TQ128

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A write message comprises the following:

control-token	24-bit response	8-bit	8-bit	data	control-token
36	channel-end identifier	register number	size		1

The response to a write message comprises either control tokens 3 and 1 (for success), or control tokens 4 and 1 (for failure).

A read message comprises the following:

control-token	24-bit response	8-bit	8-bit	control-token
37	channel-end identifier	register number	size	1

The response to the read message comprises either control token 3, data, and control-token 1 (for success), or control tokens 4 and 1 (for failure).



B.1 RAM base address: 0x00

This register contains the base address of the RAM. It is initialized to 0x00040000.

0x00: RAM base address

0:	Bits	Perm	Init	Description
se	31:2	RW		Most significant 16 bits of all addresses.
55	1:0	RO	-	Reserved

B.2 Vector base address: 0x01

Base address of event vectors in each resource. On an interrupt or event, the 16 most significant bits of the destination address are provided by this register; the least significant 16 bits come from the event vector.

0x01: Vector base address

	Bits	Perm	Init	Description
2	31:18	RW		The event and interrupt vectors.
5	17:0	RO	-	Reserved

B.3 xCORE Tile control: 0x02

Register to control features in the xCORE tile



B.25 Data breakpoint control register: 0x70 ... 0x73

This set of registers controls each of the four data watchpoints.

	Bits	Perm	Init	Description
	31:24	RO	-	Reserved
_	23:16	DRW	0	A bit for each thread in the machine allowing the breakpoint to be enabled individually for each thread.
:	15:3	RO	-	Reserved
a t	2	DRW	0	When 1 the breakpoints will be be triggered on loads.
l	1	DRW	0	Determines the break condition: $0 = A AND B$, $1 = A OR B$.
r	0	DRW	0	When 1 the instruction breakpoint is enabled.

0x70 .. 0x73: Data breakpoint control register

B.26 Resources breakpoint mask: 0x80 .. 0x83

This set of registers contains the mask for the four resource watchpoints.

0x80 .. 0x83: Resources breakpoint mask

burces kpoint	Bits	Perm	Init	Description
mask	31:0	DRW		Value.

B.27 Resources breakpoint value: 0x90 .. 0x93

This set of registers contains the value for the four resource watchpoints.

0x90 .. 0x93: Resources breakpoint value

urces point	Bits	Perm	Init	Description
/alue	31:0	DRW		Value.

B.28 Resources breakpoint control register: 0x9C .. 0x9F

This set of registers controls each of the four resource watchpoints.

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	Bits	Perm	Init	Description
	31:24	CRO		Processor ID of this XCore.
0x00:	23:16	CRO		Number of the node in which this XCore is located.
Device	15:8	CRO		XCore revision.
identification	7:0	CRO		XCore version.

C.2 xCORE Tile description 1: 0x01

This register describes the number of logical cores, synchronisers, locks and channel ends available on this xCORE tile.

Bits	Perm	Init	Description
31:24	CRO		Number of channel ends.
23:16	CRO		Number of the locks.
15:8	CRO		Number of synchronisers.
7:0	RO	-	Reserved

0x01: xCORE Tile description 1

C.3 xCORE Tile description 2: 0x02

This register describes the number of timers and clock blocks available on this xCORE tile.

0x02: xCORE Tile description 2

	Bits	Perm	Init	Description
:02:	31:16	RO	-	Reserved
Tile	15:8	CRO		Number of clock blocks.
n 2	7:0	CRO		Number of timers.

C.4 Control PSwitch permissions to debug registers: 0x04

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This register can be used to control whether the debug registers (marked with permission CRW) are accessible through the tile configuration registers. When this bit is set, write -access to those registers is disabled, preventing debugging of the xCORE tile over the interconnect.



0x04: Control PSwitch permissions to debug registers

Bits	Perm	Init	Description
31	CRW	0	When 1 the PSwitch is restricted to RO access to all CRW registers from SSwitch, XCore(PS_DBG_Scratch) and JTAG
30:1	RO	-	Reserved
0	CRW	0	When 1 the PSwitch is restricted to RO access to all CRW registers from SSwitch

C.5 Cause debug interrupts: 0x05

This register can be used to raise a debug interrupt in this xCORE tile.

0x05: Cause debug interrupts

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	CRW	0	1 when the processor is in debug mode.
0	CRW	0	Request a debug interrupt on the processor.

C.6 xCORE Tile clock divider: 0x06

This register contains the value used to divide the PLL clock to create the xCORE tile clock. The divider is enabled under control of the tile control register

0x06: xCORE Tile clock divider

Bits	Perm	Init	Description	
31	CRW	0	Clock disable. Writing '1' will remove the clock to the tile.	
30:16	RO	-	Reserved	
15:0	CRW	0	Clock divider.	

C.7 Security configuration: 0x07

Copy of the security register as read from OTP.

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D Node Configuration

The digital node control registers can be accessed using configuration reads and writes (use write_node_config_reg(device, ...) and read_node_config_reg(device, \rightarrow ...) for reads and writes).

Number	Perm	Description
0x00	RO	Device identification
0x01	RO	System switch description
0x04	RW	Switch configuration
0x05	RW	Switch node identifier
0x06	RW	PLL settings
0x07	RW	System switch clock divider
0x08	RW	Reference clock
0x09	R	System JTAG device ID register
0x0A	R	System USERCODE register
0x0C	RW	Directions 0-7
0x0D	RW	Directions 8-15
0x10	RW	Reserved
0x11	RW	Reserved.
0x1F	RO	Debug source
0x20 0x28	RW	Link status, direction, and network
0x40 0x47	RO	PLink status and network
0x80 0x88	RW	Link configuration and initialization
0xA0 0xA7	RW	Static link configuration

Figure 36: Summary

D.1 Device identification: 0x00

This register contains version and revision identifiers and the mode-pins as sampled at boot-time.

	Bits	Perm	Init	Description
	31:24	RO	-	Reserved
0x00:	23:16	RO		Sampled values of BootCtl pins on Power On Reset.
Device	15:8	RO		SSwitch revision.
ntification	7:0	RO		SSwitch version.

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Bits	Perm	Init	Description
31:28	RW	0	The direction for packets whose dimension is F.
27:24	RW	0	The direction for packets whose dimension is E.
23:20	RW	0	The direction for packets whose dimension is D.
19:16	RW	0	The direction for packets whose dimension is C.
15:12	RW	0	The direction for packets whose dimension is B.
11:8	RW	0	The direction for packets whose dimension is A.
7:4	RW	0	The direction for packets whose dimension is 9.
3:0	RW	0	The direction for packets whose dimension is 8.

0x0D: Directions 8-15

D.12 Reserved: 0x10

Reserved.

	31:2	F
0x10:	1	R
Reserved	0	F

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	RW	0	Reserved.
0	RW	0	Reserved.

D.13 Reserved.: 0x11

Reserved.

0x11: Reserved.

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	RW	0	Reserved.
0	RW	0	Reserved.

D.14 Debug source: 0x1F

Contains the source of the most recent debug event.

D.18 Static link configuration: 0xA0 .. 0xA7

These registers are used for static (ie, non-routed) links. When a link is made static, all traffic is forwarded to the designated channel end and no routing is attempted. The registers control links C, D, A, B, G, H, E, and F in that order.

Bits	Perm	Init	Description
31	RW	0	Enable static forwarding.
30:9	RO	-	Reserved
8	RW	0	The destination processor on this node that packets received in static mode are forwarded to.
7:5	RO	-	Reserved
4:0	RW	0	The destination channel end on this node that packets received in static mode are forwarded to.

0xA0 .. 0xA7: Static link configuration



E USB Node Configuration

The USB node control registers can be accessed using configuration reads and writes (use write_node_config_reg(device, ...) and read_node_config_reg(device, ...) for reads and writes).

Number	Perm	Description
0x00	RO	Device identification register
0x04	RW	Node configuration register
0x05	RW	Node identifier
0x51	RW	System clock frequency
0x80	RW	Link Control and Status

Figure 37: Summary

E.1 Device identification register: 0x00

This register contains version information, and information on power-on behavior.

0x00: Device identification register

Bits	Perm	Init	Description
31:24	RO	0x0F	Chip identifier
23:16	RO	-	Reserved
15:8	RO	0x02	Revision number of the USB block
7:0	RO	0x00	Version number of the USB block

E.2 Node configuration register: 0x04

This register is used to set the communication model to use (1 or 3 byte headers), and to prevent any further updates.

0x04: Node configuration register

	Bits	Perm	Init	Description
04: de	31	RW	0	Set to 1 to disable further updates to the node configuration and link control and status registers.
on	30:1	RO	-	Reserved
er	0	RW	0	Header mode. 0: 3-byte headers; 1: 1-byte headers.

Bits	Perm	Init	Description
31:8	RO	-	Reserved
7	RW	0	Set to 1 to switch UIFM to EXTVBUSIND mode.
6	RW	0	Set to 1 to switch UIFM to DRVVBUSEXT mode.
5	RO	-	Reserved
4	RW	0	Set to 1 to switch UIFM to UTMI+ CHRGVBUS mode.
3	RW	0	Set to 1 to switch UIFM to UTMI+ DISCHRGVBUS mode.
2	RW	0	Set to 1 to switch UIFM to UTMI+ DMPULLDOWN mode.
1	RW	0	Set to 1 to switch UIFM to UTMI+ DPPULLDOWN mode.
0	RW	0	Set to 1 to switch UIFM to IDPULLUP mode.

0x10: UIFM on-the-go control

F.6 UIFM on-the-go flags: 0x14

Status flags used for on-the-go negotiation

Bits	Perm	Init	Description
31:6	RO	-	Reserved
5	RO	0	Value of UTMI+ Bvalid flag.
4	RO	0	Value of UTMI+ IDGND flag.
3	RO	0	Value of UTMI+ HOSTDIS flag.
Ĩ	RO	0	Value of UTMI+ VBUSVLD flag.
1	RO	0	Value of UTMI+ SESSVLD flag.
(RO	0	Value of UTMI+ SESSEND flag.

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0x14: UIFM on-the-go flags

Bits	Perm	Init	Description
31:7	RO	-	Reserved
6	RO	0	1 if UIFM is in UTMI+ RXRCV mode.
5	RO	0	1 if UIFM is in UTMI+ RXDM mode.
4	RO	0	1 if UIFM is in UTMI+ RXDP mode.
3	RW	0	Set to 1 to switch UIFM to UTMI+ TXSE0 mode.
2	RW	0	Set to 1 to switch UIFM to UTMI+ TXDATA mode.
1	RW	1	Set to 0 to switch UIFM to UTMI+ TXENABLE mode.
0	RW	0	Set to 1 to switch UIFM to UTMI+ FSLSSERIAL mode.

F.7 UIFM Serial Control: 0x18

0x18: UIFM Serial Control

F.8 UIFM signal flags: 0x1C

Set of flags that monitor line and error states. These flags normally clear on the next packet, but they may be made sticky by using PER_UIFM_FLAGS_STICKY, in which they must be cleared explicitly.

Bits	Perm	Init	Description
31:7	RO	-	Reserved
6	RW	0	Set to 1 when the UIFM decodes a token successfully (e.g. it passes CRC5, PID check and has matching device address).
5	RW	0	Set to 1 when linestate indicates an SEO symbol.
4	RW	0	Set to 1 when linestate indicates a K symbol.
3	RW	0	Set to 1 when linestate indicates a J symbol.
2	RW	0	Set to 1 if an incoming datapacket fails the CRC16 check.
1	RW	0	Set to the value of the UTMI_RXACTIVE input signal.
0	RW	0	Set to the value of the UTMI_RXERROR input signal

0x1C: UIFM signal flags

F.9 UIFM Sticky flags: 0x20

These bits define the sticky-ness of the bits in the UIFM IFM FLAGS register. A 1 means that bit will be sticky (hold its value until a 1 is written to that bitfield), or normal, in which case signal updates to the UIFM IFM FLAGS bits may be over-written by subsequent changes in those signals.

0x20: UIFM Sticky flags

Bits	Perm	Init	Description
31:7	RO	-	Reserved
6:0	RW	0	Stickyness for each flag.

F.10 UIFM port masks: 0x24

Set of masks that identify how port 1N, port 1O and port 1P are affected by changes to the flags in FLAGS

Bits	Perm	Init	Description	
31:24	RW	0	Bit mask that determines which flags in UIFM_IFM_FLAG[6:0] contribute to port 1?. If any flag listed in this bitmask is high, port 1? will be high.	
23:16	RW	0	Bit mask that determines which flags in UIFM_IFM_FLAG[6: contribute to port 1P. If any flag listed in this bitmask is hig port 1P will be high.	
15:8	RW	0	Bit mask that determines which flags in UIFM_IFM_FLAG[6:0] contribute to port 10. If any flag listed in this bitmask is high, port 10 will be high.	
7:0	RW	0	Bit mask that determines which flags in UIFM_IFM_FLAG[6:0] contribute to port 1N. If any flag listed in this bitmask is high, port 1N will be high.	

0x24: UIFM port masks

F.11 UIFM SOF value: 0x28

USB Start-Of-Frame counter

0x28: UIFM SOF value

Bits	Perm	Init	Description
31:11	RO	-	Reserved
10:8	RW	0	Most significant 3 bits of SOF counter
7:0	RW	0	Least significant 8 bits of SOF counter

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F.12 UIFM PID: 0x2C

The last USB packet identifier received



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	Bits	Perm	Init	Description
0x2C:	31:4	RO	-	Reserved
UIFM PID	3:0	RO	0	Value of the last received PID.

F.13 UIFM Endpoint: 0x30

The last endpoint seen

0x30: UIFM Endpoint

	Bits	Perm	Init	Description
0:	31:5	RO	-	Reserved
и. И	4	RO	0	1 if endpoint contains a valid value.
t	3:0	RO	0	A copy of the last received endpoint.

F.14 UIFM Endpoint match: 0x34

This register can be used to mark UIFM endpoints as special.

0x34: UIFM Endpoint match

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RW	0	This register contains a bit for each endpoint. If its bit is set, the endpoint will be supplied on the RX port when ORed with $0x10$.

F.15 OTG Flags mask: 0x38

0x38: OTG Flags mask

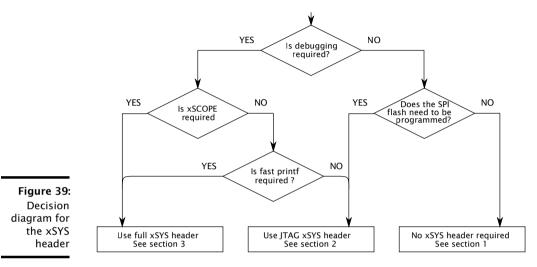
0x38: Flags	Bits	Perm	Init	Description
mask	31:0	RW	0	Data

F.16 UIFM power signalling: 0x3C

	Bits	Perm	Init	Description
0x3C:	31:9	RO	-	Reserved
UIFM power	8	RW	0	Valid
signalling	7:0	RW	0	Data

G JTAG, xSCOPE and Debugging

If you intend to design a board that can be used with the XMOS toolchain and xTAG debugger, you will need an xSYS header on your board. Figure 39 shows a decision diagram which explains what type of xSYS connectivity you need. The three subsections below explain the options in detail.



G.1 No xSYS header

The use of an xSYS header is optional, and may not be required for volume production designs. However, the XMOS toolchain expects the xSYS header; if you do not have an xSYS header then you must provide your own method for writing to flash/OTP and for debugging.

G.2 JTAG-only xSYS header

The xSYS header connects to an xTAG debugger, which has a 20-pin 0.1" female IDC header. The design will hence need a male IDC header. We advise to use a boxed header to guard against incorrect plug-ins. If you use a 90 degree angled header, make sure that pins 2, 4, 6, ..., 20 are along the edge of the PCB.

Connect pins 4, 8, 12, 16, 20 of the xSYS header to ground, and then connect:

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- ▶ TDI to pin 5 of the xSYS header
- TMS to pin 7 of the xSYS header
- TCK to pin 9 of the xSYS header
- TDO to pin 13 of the xSYS header

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J Associated Design Documentation

Document Title	Information	Document Number
Estimating Power Consumption For XS1-U Devices	Power consumption	
Programming XC on XMOS Devices	Timers, ports, clocks, cores and channels	X9577
xTIMEcomposer User Guide	Compilers, assembler and linker/mapper	X3766
	Timing analyzer, xScope, debugger	
	Flash and OTP programming utilities	

K Related Documentation

Document Title	Information	Document Number
The XMOS XS1 Architecture	ISA manual	X7879
XS1 Port I/O Timing	Port timings	X5821
xCONNECT Architecture	Link, switch and system information	X4249
XS1-U Link Performance and Design Guidelines	Link timings	
XS1-U Clock Frequency Control	Advanced clock control	